

10 mm (0.40 inch) Seven Segment Displays

Technical Data

HDSP-F15x Series HDSP-F20x Series HDSP-F30x Series HDSP-F40x Series HDSP-G00x Series HDSP-G15x Series HDSP-G20x Series HDSP-G30x Series HDSP-G40x Series HDSP-G40x Series

Features

- Industry Standard Size
- Industry Standard Pinout 7.6 mm (0.3 inch) DIP Single 15.24 mm (0.6 inch) DIP Dual Leads on 2.54 mm (0.1 inch) Centers
- Choice of Colors
 AlGaAs Red, High Efficiency
 Red, Orange, Yellow, Green
- Excellent Appearance
 Evenly Lighted Segments
 Mitered Corners on Segments
 Gray Package Gives Optimum
 Contrast
 ± 50° Viewing Angle

• Design Flexibility

Common Anode or Common Cathode Single and Dual Digits Right Hand Decimal Point ± 1. Overflow Character

• Categorized for Luminous Intensity

Yellow and Green Categorized for Color

Use of Like Categories Yields a Uniform Display

- High Light Output
- High Peak Current
- Excellent for Long Digit String Multiplexing



- Intensity and Color Selection Option
- Sunlight Viewable AlGaAs

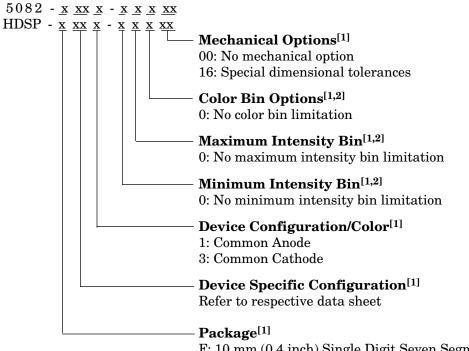
Devices

AlGaAs Red ^[1] HDSP-	HER HDSP-	Orange HDSP-	Yellow HDSP-	Green HDSP-	Description	Package Drawing
F151	F201	F401	F301	F501	Common Anode Right Hand Decimal	A
F153	F203	F403	F303	F503	Common Cathode Right Hand Decimal	В
F157	F207	F407	F307	F507	Common Anode ± 1. Overflow	С
F158	F208	F408	F308	F508	Common Cathode \pm 1. Overflow	D
G151	G201	G401	G301	G501	Two Digit Common Anode Right Hand Decimal	E
G153	G203	G403	G303	G503	Two Digit Common Cathode Right Hand Decimal	F

Note:

^{1.} These displays are recommended for high ambient light operation. Please refer to the HDSP-F10X data sheet for low current operation.

Part Numbering System



F: 10 mm (0.4 inch) Single Digit Seven Segment Display G: 10 mm (0.4 inch) Dual Digit Seven Segment Display

Notes:

- 1. For codes not listed in the figure above, please refer to the respective data sheet or contact your nearest Agilent representative for details.
- 2. Bin options refer to shippable bins for a part-number. Color and Intensity Bins are typically restricted to 1 bin per tube (exceptions may apply). Please refer to respective data sheet for specific bin limit information.

Description

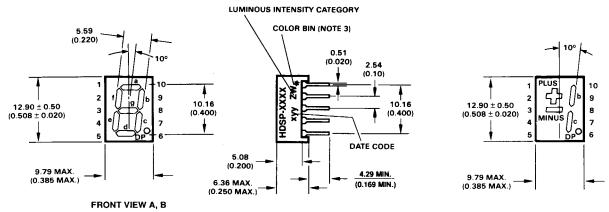
The 10 mm (0.40 inch) LED seven segment displays are Agilent's most space-efficient character size. They are designed for viewing distances up to 4.5

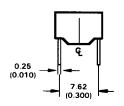
metres (15 feet). These devices use an industry standard size package and pinout. The dual numeric, single numeric, and \pm 1. overflow devices feature a right hand decimal point. All devices

are available as either common anode or common cathode.

Typical applications include instruments, point of sale terminals, and appliances.

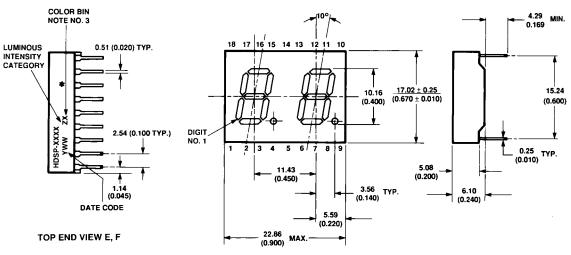
Package Dimensions





*The End View of package indicates Country of Origin.

TOP END VIEW A, B, C, D



* The End View of package indicates Country of Origin.

FRONT VIEW E, F

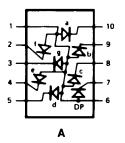
- NOTES:

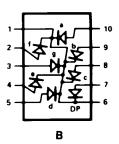
 1. DIMENSIONS ARE IN MILLIMETRES (INCHES).

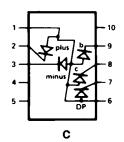
 2. ALL UNTOLERANCED DIIMENSIONS ARE FOR REFERENCE ONLY.

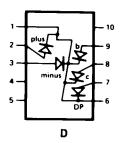
 3. WHERE APPLICABLE.

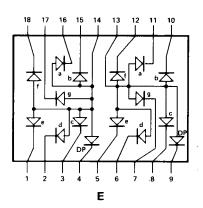
Internal Circuit Diagram

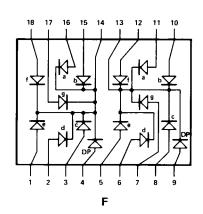








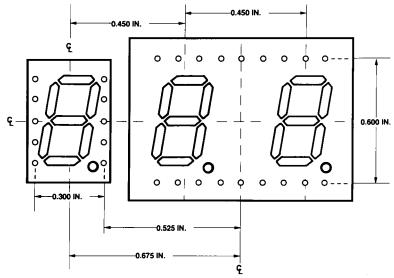




	FUNCTION							
		FUN	CTION					
PIN	Α	В	С	D				
1	ANODE ^[1]	CATHODE ^[2]	ANODE ^[1]	CATHODE ^[2]				
2	CATHODE f	ANODE f	CATHODE PLUS	ANODE PLUS				
3	CATHODEg	ANODE g	CATHODE MINUS	ANODE MINUS				
4	CATHODE e	ANODE e	NC	NC				
5	CATHODE d	ANODE d	NC	NC				
6	ANODE[1]	CATHODE[2]	ANODE[1]	CATHODE[2]				
7	CATHODE DP	ANODE DP	CATHODE DP	ANODE DP				
8	CATHODE c	ANODE c	CATHODE c	ANODE c				
9	CATHODE b	ANODE b	CATHODE b	ANODE b				
10	CATHODE a	ANODE a	NC	NC				

	FUNCTION					
PIN	E	F				
1	E CATHODE NO. 1	E ANODE NO. 1				
2	D CATHODE NO. 1	D ANODE NO. 1				
3	C CATHODE NO. 1	C ANODE NO. 1				
4	DP CATHODE NO. 1	DP ANODE NO. 1				
5	E CATHODE NO. 2	E ANODE NO. 2				
6	D CATHODE NO. 2	D ANODE NO. 2				
7	G CATHODE NO. 2	G ANODE NO. 2				
8	C CATHODE NO. 2	C ANODE NO. 2				
9	CP CATHODE NO. 2	DP ANODE NO. 2				
10	B CATHODE NO. 2	B ANODE NO. 2				
11	A CATHODE NO. 2	A ANODE NO. 2				
12	F CATHODE NO. 2	F ANODE NO. 2				
13	DIGIT NO. 2 ANODE	DIGIT NO. 2 CATHODE				
14	DIGIT NO. 1 ANODE	DIGIT NO. 1 CATHODE				
15	B CATHODE NO. 1	B ANODE NO. 1				
16	A CATHODE NO. 1	A ANODE NO. 1				
17	G CATHODE NO. 1	G ANODE NO. 1				
18	F CATHODE NO. 1	F ANODE NO. 1				

- NOTES: 1. REDUNDANT ANODES 2. REDUNDANT CATHODES



HOLE PATTERN FOR PCB LAYOUT TO ACHIEVE UNIFORM 0.450 IN. DIGIT TO DIGIT PITCH. FOR HDSP-FXXX TO HDSP-GXXX.

Absolute Maximum Ratings

Description	AlGaAs Red HDSP- F15x/G15x Series	HER/Orange HDSP- F20x/G20x/ G40x Series	Yellow HDSP- F30x/G30x Series	Green HDSP- F50x/G50x Series	Units	
Average Power per Segment or DP	96	105	80	105	mW	
Peak Forward Current per Segment or DP	160[1]	$90_{[3]}$	60 ^[5]	90[7]	mA	
DC Forward Current per Segment or DP	40[2]	$30^{[4]}$	20[6]	30[8]	mA	
Operating Temperature Range	-20 to +100 ^[9]		-40 to +100		$^{\circ}$ C	
Storage Temperature Range		–55 to	0 +100		°C	
Reverse Voltage per Segment or DP	3.0					
Lead Solder Temperature for 3 Seconds (1.59 mm [0.063 in.] below seating plane)		2	60		$^{\circ}\!\mathrm{C}$	

- See Figure 1 to establish pulsed conditions.
 Derate above 46°C at 0.54 mA/°C.
- 3. See Figure 6 to establish pulsed conditions.
 4. Derate above 53°C at 0.45 mA/°C.
- 5. See Figure 7 to establish pulsed conditions.

- 6. Derate above 81°C at 0.52 mA/°C.
- 7. See Figure 8 to establish pulsed conditions.
- 8. Derate above 39°C at 0.37 mA/°C.
 9. For operation below -20°C, contact your local Agilent components sales office or an authorized distributor.

Electrical/Optical Characteristics at $T_A = 25$ °C

AlGaAs Red

Device Series	Parameter	Symbol	Min.	Тур.	Max.	Units	Test Conditions
	Luminous Intensity/Segment ^[1,2,5] (Digit Average)	$I_{ m V}$	7.5	15.0		mcd	$I_F = 20 \text{ mA}$
	Forward Voltage/Segment or DP	V_{F}		1.8	2.2	V	$I_F = 20 \text{ mA}$
HDSP- F15x/	Peak Wavelength	$\lambda_{ ext{PEAK}}$		645		nm	
G15x	Dominant Wavelength ^[3]	$\lambda_{ m d}$		637		nm	
	Reverse Voltage/Segment or DP ^[4]	V_{R}	3.0	15		V	$I_R = 100 \mu\text{A}$
	Temperature Coefficient of $V_F/Segment \ or \ DP$	ΔV_F /°C		-2		mV/°C	
	Thermal Resistance LED Junction-to-Pin	$R\theta_{ ext{J-PIN}}$		320		°C/W/Seg	

Electrical/Optical Characteristics at T_A = 25°C, continued

High Efficiency Red

Device Series	Parameter	Symbol	Min.	Тур.	Max.	Units	Test Conditions
	Luminous Intensity/Segment ^[1,2] (Digit Average)	$I_{ m V}$	420	1200		μcd	$I_{\rm F} = 5~{\rm mA}$
	Forward Voltage/Segment or DP	V_{F}		2.0	2.5	V	$I_{\rm F} = 20~{\rm mA}$
HDSP- F20x/	Peak Wavelength	$\lambda_{ ext{PEAK}}$		635		nm	
G20x	Dominant Wavelength[3]	$\lambda_{ m d}$		626		nm	
	Reverse Voltage/Segment or DP ^[4]	V_{R}	3.0	30		V	$I_R = 100 \mu\text{A}$
	Temperature Coefficient of V_F /Segment or DP	ΔV_F /°C		-2		mV/°C	
	Thermal Resistance LED Junction-to-Pin	$R\theta_{ ext{J-PIN}}$		320		°C/W/Seg	

Orange

Device Series	Parameter	Symbol	Min.	Тур.	Max.	Units	Test Conditions
	Luminous Intensity/Segment ^[1,2] (Digit Average)	I_v	420	1200		μcd	$I_F = 5 \text{ mA}$
	Forward Voltage/Segment or DP	$V_{_{ m F}}$		2.0	2.5	V	$I_F = 20 \text{ mA}$
HDSP-	Peak Wavelength	$l_{\scriptscriptstyle PEAK}$		600		nm	
F40x/ G40x	Dominant Wavelength ^[3]	l_d		603		nm	
	Reverse Voltage/Segment or DP ^[4]	$V_{_{\mathrm{R}}}$	3.0	30		V	$I_R = 100 \mu\text{A}$
	Temperature Coefficient of V_r /Segment or DP	$\Delta V_{_{ m F}}$ /°C		-2		mV/°C	
	Thermal Resistance LED Junction-to-Pin	Rl\q _{J-PIN}		320		°C/W/Seg	

Electrical/Optical Characteristics at $T_A = 25$ °C, continued

Yellow

Device Series	Parameter	Symbol	Min.	Тур.	Max.	Units	Test Conditions
	Luminous Intensity/Segment ^[1,2] (Digit Average)	I_{V}	290	800		μcd	$I_{\rm F} = 5 \text{ mA}$
	Forward Voltage/Segment or DP	V_{F}		2.2	2.5	V	$I_F = 20 \text{ mA}$
HDSP-	Peak Wavelength	$\lambda_{ ext{PEAK}}$		583		nm	
F30x/ G30x	Dominant Wavelength ^[3,6]	$\lambda_{ m d}$	581.5	586	592.5	nm	
	Reverse Voltage/Segment or DP ^[4]	V_{R}	3.0	40		V	$I_R = 100 \mu\text{A}$
	Temperature Coefficient of $V_F/Segment$ or DP	$\Delta V_F/^{\circ}C$		-2		mV/°C	
	Thermal Resistance LED Junction-to-Pin	$ m R heta_{J ext{-PIN}}$		320		°C/W/Seg	

High Performance Green

Device Series	Parameter	Symbol	Min.	Тур.	Max.	Units	Test Conditions
	Luminous Intensity/Segment ^[1,2] (Digit Average)	$I_{ m V}$	1030	3500		μcd	$I_{\rm F} = 10 \text{ mA}$
	Forward Voltage/Segment or DP	V_{F}		2.1	2.5	V	$I_{\rm F} = 10 \text{ mA}$
HDSP- F50x/	Peak Wavelength	$\lambda_{ ext{PEAK}}$		566		nm	
G50x	Dominant Wavelength ^[3,6]	$\lambda_{ m d}$		571	577	nm	
	Reverse Voltage/Segment or DP ^[4]	V_{R}	3.0	50		V	$I_R = 100 \mu\text{A}$
	Temperature Coefficient of V_F /Segment or DP	$\Delta V_{\rm F}/{^{\circ}{ m C}}$		-2		mV/°C	
	Thermal Resistance LED Junction-to-Pin	$ m R heta_{J ext{-PIN}}$		320		°C/W/Seg	

- 1. Case temperature of device immediately prior to the intensity measurement is $25^{\circ}\!\mathrm{C}.$
- 2. The digits are categorized for luminous intensity. The intensity category is designated by a letter on the side of the package. 3. The dominant wavelength, λ_d , is derived from the CIE chromaticity diagram and is that single wavelength which defines the color of
- 4. Typical specification for reference only. Do not exceed absolute maximum ratings.
 5. For low current operation, the AlGaAs HDSP-F10X, G10X series displays are recommended. They are tested at 1 mA dc/segment and are pin for pin compatible with the HDSP-F15X/G15X series.
- 6. The Yellow (HDSP-F30X/G30X) series and Green (HDSP-F50X/G50X) series displays are categorized for dominant wavelength. The category is designated by a number adjacent to the luminous intensity category letter.

AlGaAs Red

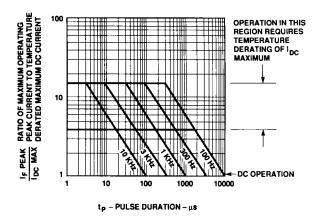


Figure 1. Maximum Tolerable Peak Current vs. Pulse Duration – AlGaAs Red.

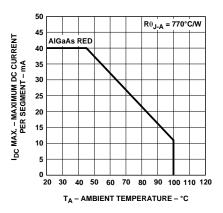


Figure 2. Maximum Allowable DC Current vs. Ambient Temperature.

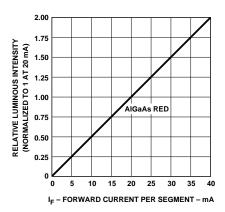


Figure 4. Relative Luminous Intensity vs. DC Forward Current.

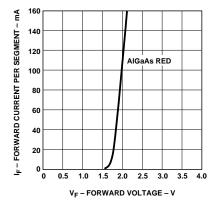


Figure 3. Forward Current vs. Forward Voltage.

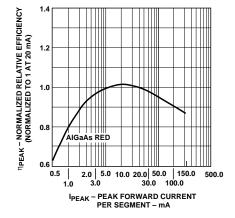


Figure 5. Relative Efficiency (Luminous Intensity per Unit Current) vs. Peak Current.

HER, Orange, Yellow, Green

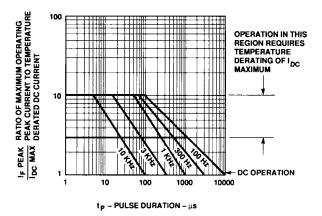


Figure 6. Maximum Tolerable Peak Current vs. Pulse Duration – HER, Orange.

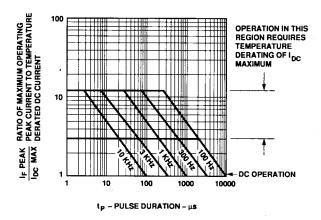


Figure 8. Maximum Tolerable Peak Current vs. Pulse Duration - Green.

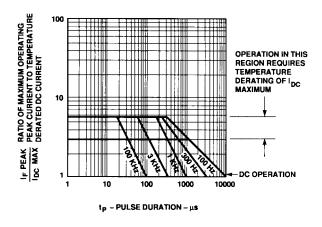


Figure 7. Maximum Tolerable Peak Current vs. Pulse Duration – Yellow.

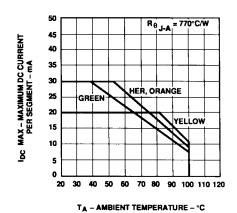


Figure 9. Maximum Allowable DC Current vs. Ambient Temperature.

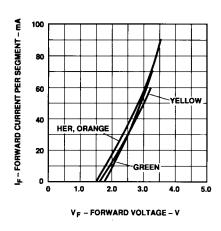


Figure 10. Forward Current vs. Forward Voltage Characteristics.

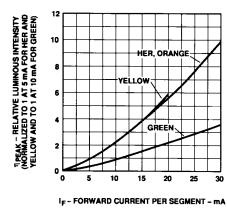


Figure 11. Relative Luminous Intensity vs. DC Forward Current.

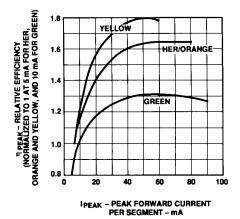


Figure 12. Relative Efficiency (Luminous Intensity per Unit Current) vs. Peak Current.

Intensity Bin Limits (mcd) AlGaAs Red

HDSP-F15x/G15x							
IV Bin Category	Max.						
L	8.67	15.90					
M	13.00	23.80					
N	19.50	35.80					
0	29.30	53.60					
P	43.90	80.50					

HER/Orange

HDSP-F20x/G20x/F40x/G40x							
IV Bin Category	Min.	Max.					
C	0.485	0.890					
D	0.728	1.333					
E	1.091	2.000					
F	1.636	3.000					
G	2.454	4.500					
Н	3.682	6.751					

Yellow

HDSP-F30x/G30x							
IV Bin Category Min. Max.							
C	0.297	0.543					
D	0.445	0.817					
Е	0.669	1.225					
F	1.003	1.838					
G	1.504	2.758					
Н	2.256	4.137					

Green

HDSP-F50x/G50x			
IV Bin Category	Min.	Max.	
Н	1.54	2.82	
I	2.31	4.23	
J	3.46	6.34	
K	5.18	9.50	
L	7.78	14.26	

Color Categories

		Dominant Wavelength (nm)	
Color	Bin	Min.	Max.
Yellow	1	581.50	585.00
	3	584.00	587.50
	2	586.50	590.00
	4	589.00	592.50
Green	2	573.00	577.00
	3	570.00	574.00
	4	567.00	571.00
	5	564.00	568.00

Note:

All categories are established for classification of products. Products may not be available in all categories. Please contact your local Agilent representatives for further clarification/information.

Contrast Enhancement

For information on contrast enhancement, please see Application Note 1015.

Soldering/Cleaning

Cleaning agents from the ketone family (acetone, methyl ethyl ketone, etc.) and from the chlorinated hydrocarbon family (methylene chloride, trichloroethylene, carbon tetrachloride, etc.) are not recommended for cleaning LED parts. All of these various solvents attack or dissolve the encapsulating epoxies used to form the package of plastic LED parts.

For further information on soldering LEDs, please refer to Application Note 1027.



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